

ZXLD1320EV1 USER GUIDE

DESCRIPTION

The ZXLD1320 is an inductive DC-DC converter, with an internal switch, designed for driving single or multiple LEDs in series up to a total of 1.5A output current.

Applications cover both commercial and automotive environments with input voltages ranging from 4V to 18V. Depending upon supply voltage and external components, this can provide up to 24W of output power.

The device employs a variable 'on' and 'off' time control scheme with adjustable peak switch current limiting and operates in the step-down (Buck) operating mode, offering higher power efficiency and lower system cost than conventional PFM circuitry.

The device includes the DC-DC converter, a high-side current monitor and an NPN switching transistor to provide an integrated solution offering small PCB size, competitive cost/performance, high power efficiency of DC-DC conversion and maximum LED brightness/reliability. More importantly, it retains design flexibility to add customer specific features.

FEATURES

- Step Down LED Driver
- 4V to 18V Input Voltage Range
- Up to 1.5A output current
- Typical efficiency $> 85\%$
- User-defined thermal control of LED output current using external thermistor
- 12 μ A typical standby current
- Adjustable Soft-Start
- Power 'OK' flag output
- Capable of driving 4 LEDs in series

ORDERING INFORMATION

| |
|---------------------|
| ORDER NUMBER |
| ZXLD1320EV1 |

Please note evaluation boards are subject to availability and qualified leads.

The feedback control circuitry inside the ZXLD1320 provides excellent load and current regulation, resulting in very stable LED current over the full operating voltage and temperature range.

The LED current can be adjusted from 100% down to 10% of the set value by applying a dc voltage to the ADJ pin and down to 1% by applying a PWM signal. An on-chip LED protection circuit also allows output current to be reduced linearly above a predetermined threshold temperature using an external thermistor at the TADJ pin.

External resistors set nominal average LED current and coil peak current independently.

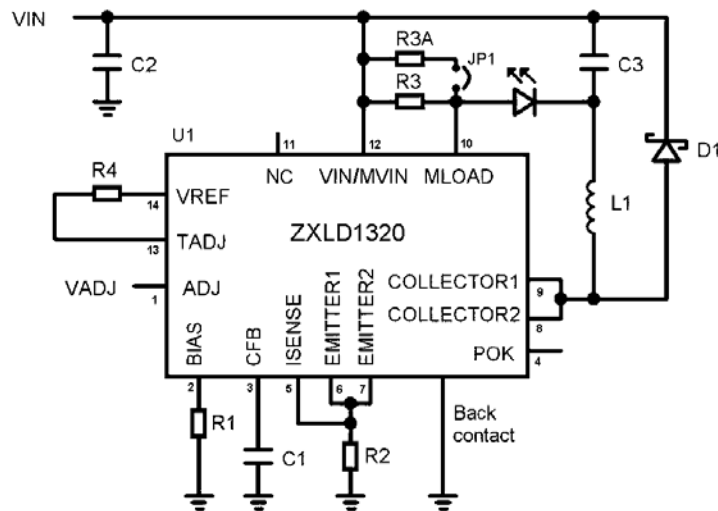
The 'Power-OK' (POK) output flag remains high during normal operation, but switches low if the switch transistor remains on for more than 500 μ s. This provides indication of a low battery, or fault condition. The POK output may be used to drive an LED or the input of an MCU.

The device can be shut down by applying a continuous low level dc voltage to the ADJ pin.

APPLICATIONS

- Low voltage halogen lamp replacement with LEDs
- High Power LED flashlights
- LED back-up lighting
- General LED lighting
- Automotive Lighting

TYPICAL APPLICATION CIRCUIT



REFERENCE DESIGN

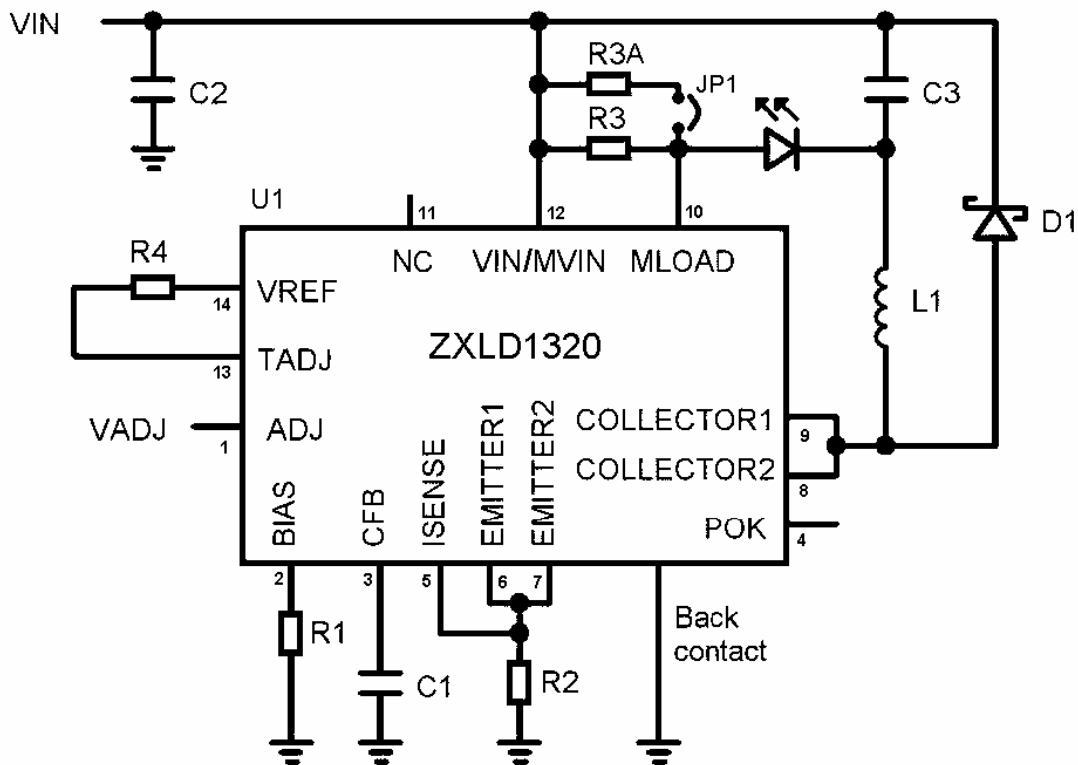
The ZXLD1320EV1 is configured to the reference design below. The target application is 1A/1.5A high current LED driver for single or multiple LEDs with wide input voltage range.

The supply voltage for ZXLD1320EV1 is: $V_{IN}=4V \sim 18V$.

The ZXLD1320EV1 boards are initially set at LED current of 1A with 100mΩ (R3) current sensing resistor. In order to boost the LED current to 1.5A, on-board 200mΩ (R3A) could be made parallel to R3 by means of soldering jumper pad JP1.

For other reference designs or further applications information please refer to the ZXLD1320 datasheet.

SCHEMATIC DIAGRAM

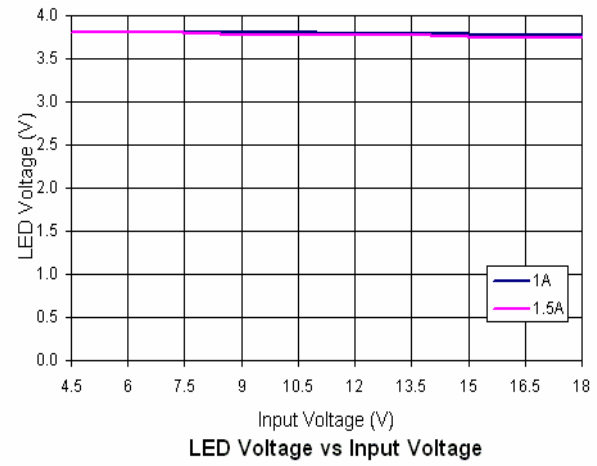
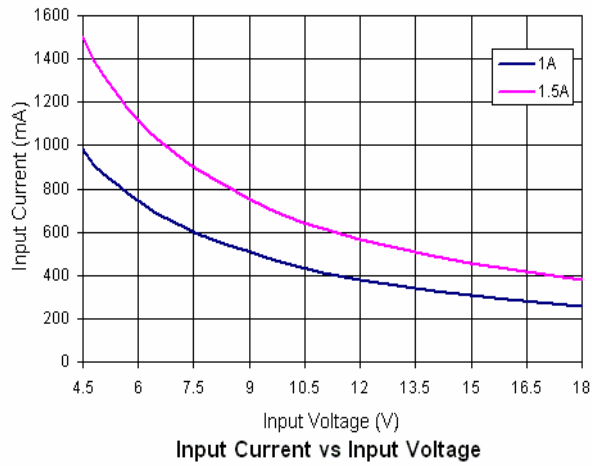
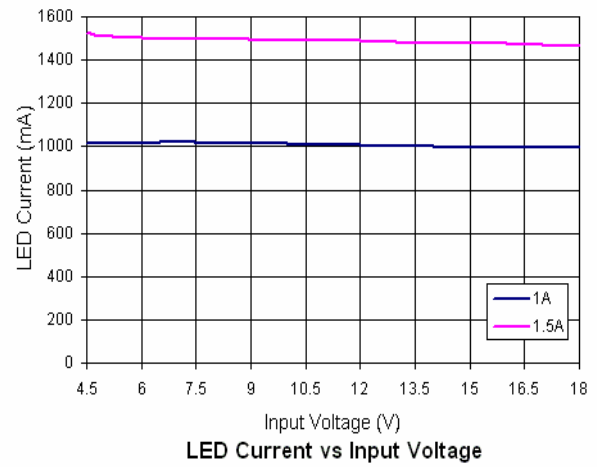
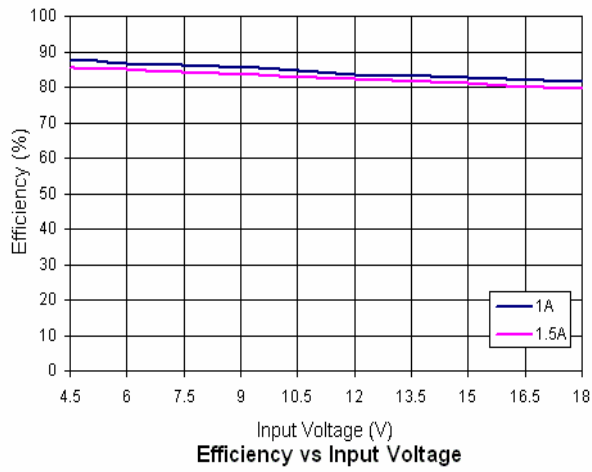


Materials List

| Ref | Value | Package | Part Number | Manufacturer | Contact Details |
|-----|----------------|---------|---|----------------------------------|--|
| U1 | LED Driver | DFN14 | ZXLD1320DCA | Zetex | www.zetex.com |
| D1 | Schottky Diode | SOT23-6 | ZHCS2000 | Zetex | www.zetex.com |
| L1 | 10uH 2A | | MSS7341-103ML NPIS64D100MTRF 744-777910 | Coilcraft NIC Comps. Würth | www.coilcraft.com www.niccomp.com www.we-online.com |
| C1 | 10nF 10V | 0603 | Generic | Generic | |
| C2 | 4.7uF 50V | 1206 | GRM31CR71H475K | Murata | www.murata.com |
| C3 | 2.2uF 25V | 1206 | GRM31MR71E225K | Murata | www.murata.com |
| R1 | 430Ω | 0805 | Generic | Generic | |
| R2 | 25mΩ | 0603 | Generic | Generic | |
| R3 | 100mΩ | 0805 | Generic | Generic | |
| R3A | 200mΩ | 0805 | Generic | Generic | |
| R4 | 5.1KΩ | 0603 | Generic | Generic | |

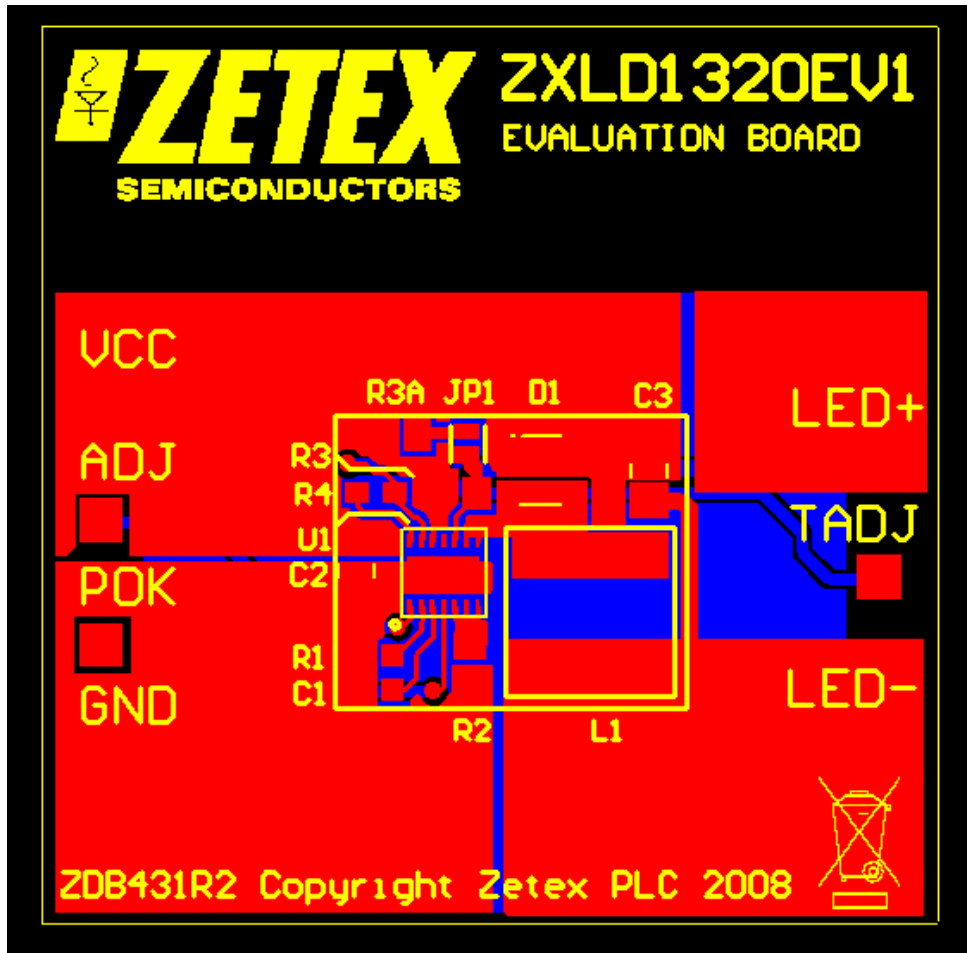
PERFORMANCE

Graphs



ZXLD1320EV1 OPERATION

Connection diagram

**ZXLD1320EV1 Set-up and Test**

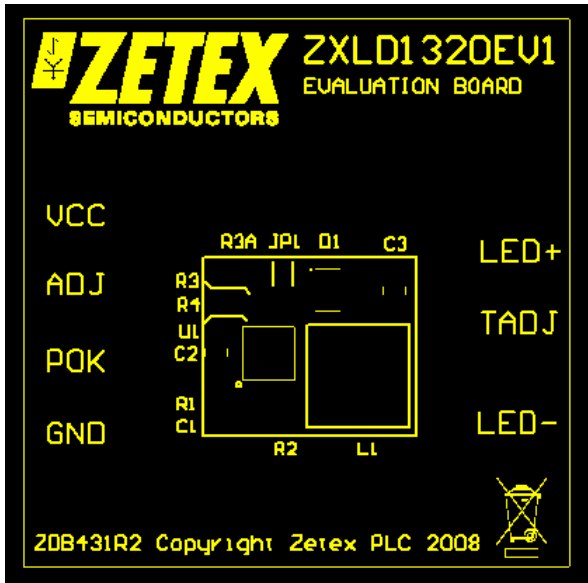
1. Preset the PSU to 8V with the current limited to around 1.5A.
2. Connect LED+ and LED- to the Anode and Cathode, respectively, of an off-board high power LED.
3. Connect V_{IN} and GND to positive and zero volts of the PSU supply respectively.
4. Turn on the PSU.
5. The LED should illuminate and be regulated at 1A/1.5A +/-5%.
6. The input current measured should be between 0.5A and 0.7A for the 1A option and between 0.8A and 1A for the 1.5A option.

Caution: A LED with an appropriate current rating should be used.

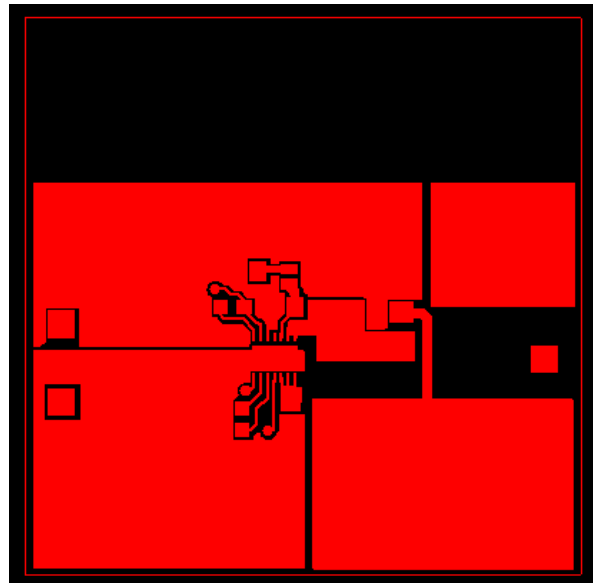
Layout considerations

The PCB tracks should be kept as short as possible to minimize ground bounce, and the ground pin of the device should be soldered directly to the ground plane. It is particularly important to mount the coil and the input/output capacitors close to the device to minimize parasitic resistance and inductance, which will degrade efficiency. Precautions should be taken to avoid noise entering the VIN pin. Input decoupling capacitor C2, between VIN and GND, should be kept as close as possible to the device. Enough copper should be attached to the GND pin (exposed pad) for heat-sinking purposes. In this evaluation board, the copper area is on the bottom layer, connected to the exposed pad through several vias.

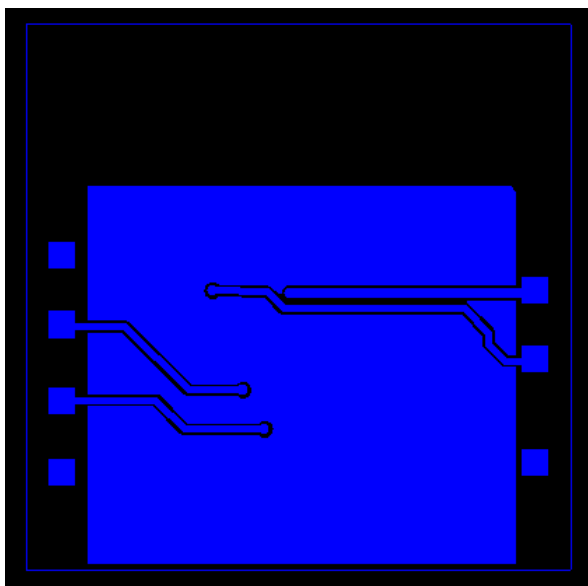
Below is the recommended layout of the ZXLD1320EV1.



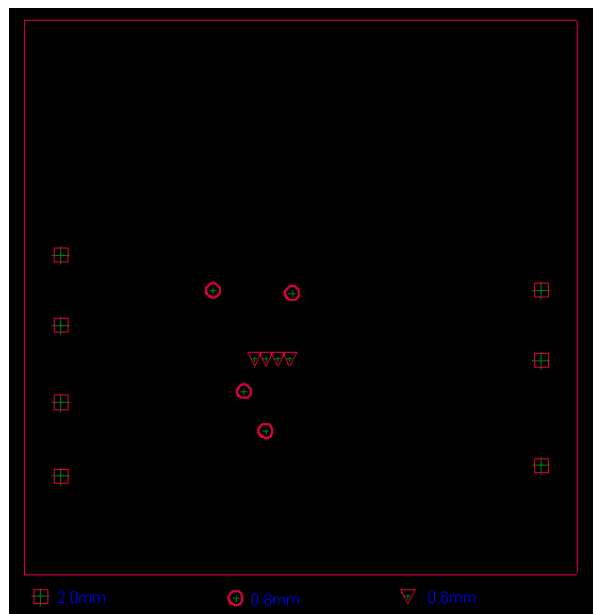
Top Silk



Top Copper



Bottom Copper



Drill File

Notes

Notes

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Product status key:

- "Preview" Future device intended for production at some point. Samples may be available
- "Active" Product status recommended for new designs
- "Last time buy (LTB)" Device will be discontinued and last time buy period and delivery is in effect
- "Not recommended for new designs" Device is still in production to support existing designs and production
- "Obsolete" Production has been discontinued

Datasheet status key:

- "Draft version" This term denotes a very early datasheet version and contains highly provisional information, which may change in any manner without notice.
- "Provisional version" This term denotes a pre-release datasheet. It provides a clear indication of anticipated performance. However, changes to the test conditions and specifications may occur, at any time and without notice.
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